

REMARKS

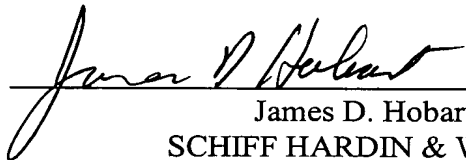
The specification, on page 5, has been amended to correct an error in the citation of the periodical Advancing Microelectronics.

In accordance with the provisions of 37 CFR 1.56, 1.97 and 1.98, it is requested that a citation and examination of the reference listed on the attached Form PTO-1449 be made during the course of the examination of the above-identified application.

In the Information Disclosure Statement which was forward to the Patent Office by Certificate on January 2, 2002, applicant noted that he did not have a copy of the pages from the periodical mentioned on page 5 of the specification. Attached herewith is a copy of pages 15-18 from Advancing Microelectronics. It is respectfully submitted that the specification distinguishes the claimed invention over the teachings of this article and that the claims are patentable thereover.

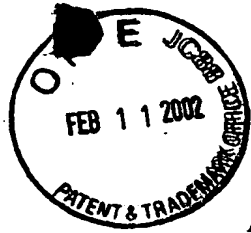
It is respectfully submitted that no additional fee is required for the Patent Office to consider this reference, since it is being filed within three months of the November 29, 2001 filing date of the application.

Respectfully submitted,

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APPENDIX

Version with markings to show changes made.

IN THE SPECIFICATION:

Page 5, paragraph starting at line 1:

--A film composed of LCP (Liquid Crystal Polymer) or a material with similar thermal expansion characteristics is highly suitable for use as a material for the intermediate base. This material is described, for example, in an article in [the Journal] Advancing Microelectronics, July/August 1998, [page] pages 15-18.--

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